



# **Experimental Investigation of Laser Ablation Characteristics on Nickel-Coated Beryllium Copper**

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Article

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**Abstract:** As electronic products are miniaturized, the components of the spring contact probe are made very fine. Current mechanical processing may make it difficult to perform micro-machining with a high degree of precision. A laser is often used for the high precision micro-machining due to its advantages such as a contact-free process, high energy concentration, fast processing time, and applicability to almost every material. The production of micro-electronics using nickel-coated copper is rapidly increasing and laser material processing is becoming a key processing technology owing to high precision requirements. Before applying laser material processing, it is necessary to understand the ablation characteristics of the materials. Therefore, this study systematically investigates the ablation characteristics of nickel-coated beryllium copper. Key laser parameters are pulse duration (4~200 ns) and the total accumulated energy (1~1000 mJ). The processed workpiece is evaluated by analyzing the heat affected zone (HAZ), material removal zone (MRZ), and roundness. Moreover, the surface characteristics such as a burr, spatter, and roundness shapes are analyzed using scanning electron microscope (SEM).

**Keywords:** laser ablation; ablation characteristics; material removal zone; heat affected zone; roundness; nickel-coated beryllium copper

# 1. Introduction

Spring contact probes are used to test printed circuit boards, semiconductors, and other electronic components. The spring contact probes consist of a plunger, barrel, and internal spring [1]. While the barrel and internal spring are relatively standardized in their manufacturing processes, the manufacturing process of the plunger is not standardized due to the variety in their shape. In mass production, plungers are stamped together and each plunger is connected with a plunger connecting arm. These connecting arms are removed to cut the plungers into pieces. Mechanical cutting is currently used. However, this may have disadvantages such as engaging mechanical force, accumulating mechanical stress, and damaging the body of plungers. In addition, a cutting tool wears out over time. Due to these disadvantages, the manufacturing process may result in poor cut quality so that the production yield decreases and inspection performance deteriorates.

To overcome these disadvantages caused by the mechanical cutting, a laser is intensively used [2–7], since laser processing has advantages such as a contact-free process, high energy concentration, fast processing time, and applicability to almost every material. Due to these advantages, laser material processing is actively studied for a variety of cutting and drilling processes [1,8–20]. Conventional laser cutting and drilling processes can be modified to the laser spot cutting to efficiently remove the connecting arms [1]. Lee et al. [1] have applied laser spot cutting on the plunger and the applicability of the laser spot cutting was tested. In this study, the penetration and material removal zone were measured, and the laser parameters for a good cut

quality were selected and validated. Even though the pulse duration of the laser used in Lee's study could be varied from 4 ns to 200 ns, it was limited only to the laser pulse duration of 200 ns.

While maintaining the electrical conductivity of electronic products, in order to prevent effects of corrosion and wear, a nickel coating is often used [21]. The nickel coating is good in color and has relatively low discoloration. In addition, the nickel coating has advantages such as a suitable hardness and good mechanical anti-corrosive effect. Therefore, the nickel coating is widely used. For example, it is used in electronic products such as ultra-small capacitors, inductors, and resistors [22,23]. Also, it is used as a material for spring contact probes to evaluate the conductivity of semiconductor devices [1,24]. Although the production of high-precision compact electronic products using nickel-coated copper is increasing rapid, systematic studies for processing nickel-coated copper with lasers are relatively sparse. Especially before applying laser material processing, it is necessary to preferentially understand the materials used and the laser interaction characteristics. In this study, the ablation characteristics for the nickel-coated beryllium copper are studied.

This paper is organized as follows. First, experimental specimens, set-up, and laser parameters are explained. Second, the analysis method is explained. Third, the experimental results and analysis are described. Finally, conclusions are summarized.

## 2. Experiment

#### 2.1. Material and Experimental Method

Nickel of 0.5  $\mu$ m thick was coated on the top and bottom surfaces of a beryllium copper (BeCu) specimen of 45  $\mu$ m thick. Thus, the total thickness of the specimen used in this experiment is 46  $\mu$ m. BeCu is a copper alloy with 1.8~2% beryllium and has been used intensively in DC probing [25]. The configuration of the experimental equipment is shown in Figure 1. This experiment used an ns pulsed ytterbium fiber laser (IPG-YLPM) (IPG photonics, Oxford, MA, U.S.A.) with a wavelength of 1064 nm and maximum average output laser power of 20 W. The laser beam was focused on the top surface of the workpiece. The spot size was 30  $\mu$ m at the focal position. The laser beam had a Gaussian distribution. This fiber laser was connected to a 3D galvo-scanner (RAYLASE AS-12Y) (Raylase, Wessling, Germany), which was able to send the laser the desired pattern at high speeds and was controlled by a computer. In order to obtain high productivity, the average maximum output laser power was used since high laser power typically leads to a high processing speed. For lasers with relatively long pulses such as the nanosecond laser, heat damage is applied not only to the processing area, but also to the edge of the area. As a result, the melting phenomenon occurs secondarily at the hole edge. Therefore, in order to have a good quality cut, it is necessary to find a set of parameters that have a narrow heat affect zone (HAZ) and reduced burr.



Figure 1. Experimental set-up.

Regarding the parameters, the value of the laser parameters applied to the specimen is shown in Table 1. While changing the pulse duration ( $\Delta t$ ) to 4 ns~200 ns, the total accumulated energy ( $E_{Total}$ ) remained at the same value, by adjusting the number of pulses and the repetition rate. Since the pulse duration is different, the time required to transfer the heat energy varies. As a result, the surface phenomenon appears differently. The pulse energy is calculated by the following Equation (1):

$$E = \frac{P_{avg}}{f} = P_{peak}\Delta t \tag{1}$$

In the above equation, *E* is the generated pulse energy per one pulse,  $P_{avg}$  is the average laser power,  $\Delta t$  is the pulse duration,  $P_{peak}$  is the peak power, and *f* is the repetition rate. Basically, the pulse energy is inversely proportional to the repetition rate. The total irradiated laser energy (*E*<sub>Total</sub>) is expressed by the following Equation (2):

$$E_{Total} = E \times N \tag{2}$$

In the above equation, *N* is the number of pulses, and in order to obtain the same total energy for each pulse duration, it is necessary to adjust the number of pulses.

#### 2.2. Analysis Method

After the experiments were conducted in accordance with the parameter table, in order to confirm the experimental results, a scanning electron microscope (SEM) (Zeiss, Oberkochen, Germany) was used to observe the surface of the sample. The heat affected zone (HAZ) and the top of the material removal zone (MRZ top) were measured. If penetrated, the bottom of the material removal zone (MRZ bottom) was also measured. Figure 2 shows the MRZ and the HAZ after laser radiation. The HAZ is defined as a melting trace around the crater due to the heat generated during laser irradiation. The MRZ refers to the hole of the material that is removed due to melting and evaporation during the laser-material interaction. During laser-material interaction, a recoil pressure is formed due to melting and evaporation processes. This recoil pressure moves molten material away from the center of a laser-material interaction zone to the edge of the MRZ. This molten material re-solidifies a crater-shaped layer around the hole edge, which is defined as the burr [26–29].



Figure 2. The scanning electron microscope (SEM) image describing measurement of the heat affectzone(HAZ)andmaterialremovalzone(MRZ).

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Table 1. Laser parameters.															
			Total E (mJ)												
Pulse Duration (ns)	Repetition Rate (kHz)	Pulse Energy (uJ)	1000	800	500	200	100	80	50	20	10	8	5	2	1
Number of Pulse (#)															
200	20	1000	1000	800	500	200	100	80	50	20	10	8	5	2	1
100	40	500	2000	1600	1000	400	200	160	100	40	20	16	10	4	2
50	60	333.3	3000	2400	1500	600	300	240	150	60	30	24	15	6	3
20	105	190.5	5250	4200	2625	1050	525	420	263	105	53	42	26	11	5
8	200	100	10,000	8000	5000	2000	1000	800	500	200	100	80	50	20	10
4	500	40	25,000	20,000	12,500	5000	2500	2000	1250	500	250	200	125	50	25

Table 1. Laser parameters.

Roundness was also measured to evaluate the quality. Roundness refers to the degree that a cross-sectional contour shape resembles an ideal perfect circle. Roundness is affected by pulse duration ( $\Delta t$ ), total accumulated energy ( $E_{Total}$ ), repetition rate (f), and a number of pulses (#). The roundness measurement is shown in Figure 3. To measure the roundness, this study assumes that the Gaussian beam is homogenous and the incoming laser beam is perpendicular to the surface of workpieces. First, the circumscribed circle and the inscribed circle were drawn concentrically on the contour of the hole. Second, the distance between the two circles was measured. As this interval tends to zero, it is close to a perfect circle. The measured roundness was tabulated as a percentage to facilitate comparison using Equation (3):

$$Roundness = \frac{R_{In}}{R_{out}} \times 100(\%) \tag{3}$$

In the above equation,  $R_{In}$  is the radius of the inscribing circle in the contour shape, and  $R_{out}$  is the radius of the circumscribing circle. As the calculated value is larger, it is close to the perfect circle.



Figure 3. Roundness measurement.

## 3. Results and Discussions

#### 3.1. Heat Affected Zone, Material Removal Zone, and Roundness

The size of the heat affected zone (HAZ) and the size of the top and bottom material removal zones (MRZ top, bottom) are measured and plotted. Figures 4–6 show the HAZ, MRZ Top, and MRZ bottom graphs in order. The *x*-axis (*E*<sub>Total</sub>) is expressed as a logarithmic scale. For reference, the series with  $\Delta t = 4$  ns mostly lacked measurements because there was no trace on the surface or the number of laser pulses on the parameters exceeded the number of pulses possible for the experimental equipment. As a result, with the current experimental conditions, the experiment could be done. For the MRZ Bottom graph, non-penetrating measurements are excluded. In Figures 4–6, it can be seen that the size of HAZ and MRZ (Top, Bottom) increases as *E*<sub>Total</sub> increases across all graphs. Also considering the HAZ and MRZ (Top, Bottom) graphs, the change in the HAZ and MRZ (Top, Bottom) size is relatively small in the section where *E*<sub>Total</sub> = 10 mJ or less for all  $\Delta t$ . Moreover, in the HAZ and MRZ (Top, Bottom) graphs,  $\Delta t$  can be classified as long pulses ( $\Delta t = 50$ , 100, 200 ns) and short pulses ( $\Delta t = 4$ , 8, 20 ns). The hole sizes of the long pulses increase steadily with little deviation as *E*<sub>Total</sub> increases.



**Figure 4.** Heat affect zone (HAZ) with the pulse duration from 4 ns to 200 ns. The HAZ of the long pulses ( $\Delta t$  = 50, 100, 200 ns) increase steadily with little deviation as *E*<sub>Total</sub> increases. On the other hand, the short pulses ( $\Delta t$  = 4, 8, 20 ns) have a large deviation of hole sizes and the sizes rise sharply as *E*<sub>Total</sub> increases.



**Figure 5.** Material removal zone (Top) with the pulse duration from 4 ns to 200 ns The HAZ of the long pulses ( $\Delta t$  = 50, 100, 200 ns) increase steadily with little deviation as *E*<sub>Total</sub> increases. On the other hand, the short pulses ( $\Delta t$  = 4, 8, 20 ns) have a large deviation of hole sizes and the sizes rise sharply as *E*<sub>Total</sub> increases.



Figure 6. Material removal zone (Bottom) with the pulse duration from 4 ns to 200 ns.

In order to analyze the degree of change for the HAZ and MRZ (Top, Bottom) values by  $\Delta t$ , the HAZ variation ( $\Delta HAZ$ ) and the MRZ variation ( $\Delta MRZ$ ) according to the *E*<sub>Total</sub> change are obtained.  $\Delta HAZ$  is calculated from Equation (4):

$$\Delta HAZ = HAZ_{Max} - HAZ_{Min} \tag{4}$$

 $\Delta MRZ$  is calculated from Equation (5):

$$\Delta MRZ = MRZ_{Max} - MRZ_{Min} \tag{5}$$

The  $\Delta MRZ$  at the top surface is expressed as  $\Delta (MRZ)_{Top}$  and the  $\Delta MRZ$  at the bottom surface is expressed as  $\Delta(MRZ)_{Bottom}$ . Each variation is summarized in Table 2. Based on this table, each variation is shown in Figure 7. First, in the case of  $\Delta HAZ$ ,  $\Delta HAZ$  is 15.66 µm at  $\Delta t$  = 200 ns, which is the smallest of all the  $\Delta t$  series. At  $\Delta t$  = 100 and 50 ns,  $\Delta HAZ$  is 25.93 and 46.58 µm, respectively. At  $\Delta t$  = 20, 8, and 4 ns,  $\Delta HAZ$  is 89.31, 157.1, and 158.1 µm, respectively, which are relatively large values compared to those at  $\Delta t = 200$ , 100, and 50 ns. Secondly, in the case of MRZ Top,  $\Delta (MRZ)_{Top}$  is 19.22  $\mu$ m at  $\Delta t$  = 200 ns.  $\Delta (MRZ)_{Top}$  is 14.69  $\mu$ m at  $\Delta t$  = 100 ns, which is the smallest of all  $\Delta t$  series. At  $\Delta t = 50$  ns,  $\Delta (MRZ)_{Top}$  is 28.84 $\mu$ m. At  $\Delta t = 20$ , 8 and 4 ns,  $\Delta (MRZ)_{Top}$  is 54.58, 123.0, and 125.2  $\mu$ m, respectively. Especially, the values at  $\Delta t = 8$ , 4 ns are relatively large compared to the values at  $\Delta t =$ 200, 100, and 50 ns. Thirdly, in the case of MRZ Bottom,  $\Delta(MRZ)_{Bottom}$  is 10.96 µm at  $\Delta t$  = 100 ns.  $\Delta(MRZ)_{Bottom}$  is 2.362 µm at  $\Delta t$  = 100 ns, which is the smallest of all  $\Delta t$  series. At  $\Delta t$  = 50 ns,  $\Delta(MRZ)$  Bottom is 12.01 µm. At  $\Delta t = 20, 8, 4$  ns,  $\Delta(MRZ)$  Bottom is 36.68, 111.7 and 74.31 µm respectively. Especially, the values at  $\Delta t$  = 8, 4 ns are relatively greater than the values at  $\Delta t$  = 200, 100, and 50 ns. In this analysis of the variation graph, it is clearly confirmed that  $\Delta HAZ$ ,  $\Delta (MRZ)_{Top}$  and  $\Delta (MRZ)_{Bottom}$ values tend to increase as the pulse duration decreases. This trend is related to the pulse energy and repetition rate. The material removal process, which is caused by two forms such as vaporization and liquid melt expulsion, can affect the observed trend. Heat is accumulated more on the workpiece during pulsed laser material processing if the repetition rate increases, even though pulse energy decreases [30]. If more heat is accumulated, the material removal is attributed to vaporization more than liquid melt expulsion. Thus, the vaporization may contribute more than

melt expulsion to remove the material if shorter laser pulses, having a relatively lower pulse energy and higher repetition rate, are used. Since the material could be removed more efficiently and effectively by vaporization than melt expulsion, the difference observed in Table 2 and Figure 7 can be explained.

Pulse Duration (ns)	$\Delta HAZ$ ( $\mu$ m)	$\Delta(MRZ)_{Top}$ (µm)	$\Delta(MRZ)$ Bottom ( $\mu$ m)
200	15.656	19.221	10.958
100	25.932	14.687	2.362
50	46.583	28.84	12.008
20	89.307	54.58	36.682
8	157.133	123.019	111.748
4	158.073	125.15	74.305





**Figure 7.** Comparison of  $\Delta HAZ$ ,  $\Delta MRZ_{Top}$ , and  $\Delta MRZ_{Bottom}$  with the pulse duration from 4 ns to 200 ns. These values tend to increase as the pulse duration decreases. This can be explained by heat accumulation and material removal mechanism with effect of laser repetition rate and pulse energy.

Table 3 shows roundness values. For reference, in all the  $\Delta t$  series, the section with low  $E_{Total}$  is not penetrated, and only a small amount of melting trace is generated, so the roundness could not be measured and the value is excluded. These excluded values are expressed as 'X' in the table. Also, at  $\Delta t$  = 4 ns series, the measured values of  $E_{Total}$  = 500, 800, and 1000 mJ are not shown. Because the number of laser pulses on the parameter exceeded the number of pulses that can be set for the experimental equipment, the experiment could not be done with the current experimental conditions. Therefore, these values are excluded and are expressed as 'No Exp' in the table. Figure 8 is a graph of roundness according to  $\Delta t$  series. At  $\Delta t$  = 200 ns series, roundness is almost constant regardless of  $E_{Total}$ . At  $\Delta t = 100$  ns series, the roundness is almost constant at  $E_{Total} = 200$  mJ or less, but the roundness is decreased at 500 mJ or more. At  $\Delta t = 50$  ns series, the roundness is almost constant at  $E_{Total}$  = 100 mJ or less, but the roundness is decreased at 200 mJ or more. At  $\Delta t$  = 20 ns series, the roundness is almost constant at  $E_{Total}$  = 200 mJ or less, but the roundness is decreased at 500 mJ or more. At  $\Delta t = 8$  ns series, the roundness is almost constant at  $E_{Total} = 100$  mJ or less, but the roundness is decreased at 200 mJ or more. Overall, the roundness value can be confirmed to decrease as the E<sub>Total</sub> increases. This is because, if the number of repetitive pulses is small (i.e., low *E*<sub>Total</sub>), the surface will be relatively flat and radiate transmitted heat symmetrically. However, as the number of pulses increases (i.e., high  $E_{Total}$ ), the molten portion of the material will become larger and the molten surface will be relatively rugged, resulting in an asymmetric heat transfer.

		Total E (mJ)											
Pulse Duration (ns)	1000	800	500	200	100	80	50	20	10	8	5	2	1
Roundness (%)													
200	61.43	62.07	68.9	69.85	67.21	66.13	69.3	68.33	66.67	-	-	-	-
100	47.89	48.21	60	70.4	71.15	68.75	73.91	70	67	68.27	69.57	-	-
50	50.66	51.56	58.65	66.36	71.43	74.7	72.63	77.32	72.94	71.6	71.23	-	-
20	48.89	54.76	62.16	78.89	72.97	71.19	68.63	67.35	68.42	67.24	67.65	-	-
8	57.96	54.39	54.43	61.11	71.15	78.85	76.32	75.68	75.4	74.07	73.91	-	-
4	No Exp	No Exp	No Exp	55	64 44	69.05	-	-	-	-	-	-	-

Table 3. Roundness.



**Figure 8.** Roundness with the pulse duration from 4 ns to 200 ns. The roundness decreases as the  $E_{Total}$  increases. This is because, with low  $E_{Total}$ , the surface will be relatively flat and radiate transmitted heat symmetrically. However, with high  $E_{Total}$ , the molten portion of the material will become larger and the molten surface will be relatively rugged, resulting in an asymmetric heat transfer.

#### 3.2. Observation of Surface Characteristics

The surface characteristics of laser and material interaction are observed by SEM photographs. The experimental specimens are taken by SEM and the surface photographs of the specimens are compiled according to  $\Delta t$  (Figures 9–13). In the case of the photos of  $\Delta t$  = 4 ns series, pulse energy is very low, so it is omitted because it has mostly no trace and no penetration. In all  $\Delta t$  series overall, round machining residue or a strong spatter mark of molten materials in the radial direction are observed around the MRZ surface. At  $\Delta t = 200$  ns series, the burr is created around the hole as a whole at all *E*<sub>Total</sub>. Especially at *E*<sub>Total</sub> = 10 and 8 mJ, a thick burr is observed. Below *E*<sub>Total</sub> = 8 mJ, only the melting marks are formed. At  $\Delta t = 100$  and 50 ns, on the whole, a relatively thick burr is observed around the MRZ. Through this, it can be deduced that the recoil pressure generated by the laser interaction repeatedly pushes the molten material in the radial direction. At  $\Delta t$  = 100 ns series, it can be observed that width is not constant compared to  $\Delta t = 50$  ns series. In addition, in both series, below  $E_{Total} = 2$  mJ, only melting marks are formed. At  $\Delta t = 20$  ns series, only a small burr is generated at  $E_{Total} = 80$  mJ or more, and a burr with no constant width is created at  $E_{Total} = 50$  mJ or less. In addition, at  $E_{Total}$  = 2 mJ or less, it is not penetrated. Finally, at  $\Delta t$  = 8 ns series, the burr is almost not generated as a whole. Furthermore, at *E*<sub>Total</sub> = 200~1000 mJ, the surface around the MRZ is crumpled, and only a slight melting trace is observed at *E*<sub>Total</sub> of 2 mJ or less.





**Figure 9.** SEM images of laser ablation with  $\Delta t$  = 200 ns.



**Figure 10.** SEM images of laser ablation with  $\Delta t = 100$  ns.



**Figure 11.** SEM images of laser ablation with  $\Delta t$  = 50 ns.



**Figure 12.** SEM images of laser ablation with  $\Delta t$  = 20 ns.



**Figure 13.** SEM images of laser ablation with  $\Delta t = 8$  ns.

In the case of roundness, SEM photographs are observed in comparison with the results of the roundness graph analysis. At all  $\Delta t$  series in the roundness graph, according to  $E_{Total}$  change, there is a section where the roundness values are constantly high and a section where the roundness values are decreased. At all  $\Delta t$  series in the SEM photographs, the MRZ shapes with the high roundness values show an almost perfect circle, and the MRZ shapes with the low roundness values show a distorted shape or an ellipse.

### 4. Conclusions

As the production of micro-electronics using nickel-coated copper is rapidly increasing, laser material processing is becoming a key processing technology due to high precision requirements. However, systematic studies on the processing of nickel-coated copper using a laser are relatively insufficient. Therefore, in this study, the interaction between nickel-coated beryllium copper (BeCu) and lasers are studied in terms of the heat affected zone (HAZ), material removal zone (MRZ), and roundness.

First, the pulse duration of long pulses ( $\Delta t = 50$ , 100, 200 ns) has a relatively wide MRZ and a small deviation of hole diameter. On the other hand, the pulse duration of lower series ( $\Delta t = 4$ , 8, 20 ns) has a very large deviation of hole diameter. Thus, a series with a low  $\Delta t$  is a process sensitive to the change of the Total Accumulated Energy ( $E_{Total}$ ). Next, the roundness graph is analyzed. Common to all  $\Delta t$  series, if the energy is too high, the roundness is not good due to an excessive heat effect. On the contrary, if the energy is too low, the processing is not successful. In the SEM photograph, the surface of the specimen is observed according to  $E_{Total}$  change for each  $\Delta t$  series. At all  $E_{Total}$  of  $\Delta t = 200$  and 100 ns series and above  $E_{Total} = 20$  mJ of  $\Delta t = 50$  ns series, the burr is thick and large. The interaction characteristics between the laser and nickel-coated BeCu discussed in this paper will be a good reference for further research in the area of laser machining.

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